## 506157352 07/16/2020

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6204085

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
HYONI KIM	11/21/2018
JIYOUN CHA	11/21/2018
HYUNGGON RYU	11/21/2018
BYEONGWOOK KIM	11/21/2018
SEUNGBEOM PARK	11/21/2018

#### RECEIVING PARTY DATA

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Postal Code:	07336

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	35507663

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	IUMBER: 0630-8456PUS1	
NAME OF SUBMITTER:	TAMMY L. MILLER	
SIGNATURE:	/Tammy L. Miller/	
DATE SIGNED:	07/16/2020	

**Total Attachments: 2** 

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# BIRCH, STEWART, KOLASCH & BIRCH, LLP

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# **ASSIGNMENT**

Application No	o.: 35/507,663	Filed: 05/02/2019	****
nsert Name(s) of nventor(s)	WITEKEAS, JITOUH CHA, BYEUNGWO	LL CAPS))*** ok KIM; HyonI KIM; Hyunggon RYU; SeungBeom PARK gned) has (have) invented certain new and useful improvements ir	n:
nsert Title of nvention	<sup>⇔</sup> Mobile Phone		
	for which an application for Letters undersigned (except in the case of a pr	Patent of the United States of America has been executed by the rovisional application)	1e
insert Date of Signing of Appln.	⇔ on November 21, 2018	; an	ıd
insert Name of Assignee	⇒ WHEREAS, LG ELECTRONICS INC		
Insert Address of Assignee	⇒ of 128, Yeoui-daero, Yeongdeungpo-	gu, Seoul, 07336, Republic of Korea	
		ives and assigns (hereinafter designated as the Assignee) is desiron interest in and to said invention and in and to any Letters Patent( nited States of America and	
Check Box if Appropriate	⇒ ☐ in any foreign countries.		
	the undersigned has (have) sold, ass and transfer unto said Assignee the f America, its territories, dependencies and all Letters Patent(s) which may dependencies and possessions, and if	aluable consideration, the receipt of which is hereby acknowledge igned and transferred, and by these presents does (do) sell, assignated and exclusive right to the said invention in the United States and possessions and the entire right, title and interest in and to a be granted therefor in the United States of America, its territorical the box above is designated, in any and all foreign countries; and inuations, conversions and extensions thereof for the full terminated.	gn of ny es, to

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of (a) valid United States of America patent(s) or a grant of (a) valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	11/21/2018	Name of Inventor	(Signature) JiYoun CHA	
Date	11/21/2018	Name of Inventor	(Signature) Byeongwook KIM	
Date	11/21/2018	Name of Inventor	Signature) HyonI KIM	
Date	11/21/2018	Name of Inventor	(Signature) Hyunggon RYU	
Date BIRCH	11/21/2018 I, STEWART, KOLASCH & BIRCH, LLP	Name of Inventor	(Signature) SeungBeom PARK Page 2	

RECORDED: 07/16/2020

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